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Title:Extremely high extinction ratio terahertz broadband polarizer using bilayer subwavelength metal wire-grid structure

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Abstract:We report a broadband terahertz (THz) polarizer exhibiting extremely high polarization extinction ratio and the method to fabricate it. The polarizer consists of a bilayer subwavelength Au wire-grid structure fabricated on Si substrate by one step etching and metal formation. The THz time domain spectroscopy (THz-TDS) measurement reveals an extremely high extinction ratio of 84.9 dB at 1.67 THz, close to the detection limit of THz-TDS system, and an average extinction ratio of 69.9 dB in 0.6-3 THz frequency range. The fabricated bilayer wire-grid polarizer shows greatly enhanced performance over conventional single layer wire-grid THz polarizer. &copy; 2012 American Institute of Physics.

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Controlled terms:Laser pulses - Light extinction - Wire

Uncontrolled terms:Bi-layer - Broadband terahertz - Detection limits - Extinction ratios - Polarization extinction ratio - Si substrates - Single layer - Sub-wavelength - Tera Hertz - THz frequencies - THz time domain spectroscopy - THz-TDS - Wire grid polarizers

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